504387515 05/29/2017

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 EPAS ID: PAT4434211 Stylesheet Version v1.2

 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
PREETHAM RAO	05/12/2017
ANANTHKRISHNA JUPUDI	05/12/2017

RECEIVING PARTY DATA

Name:	APPLIED MATERIALS SINGAPORE TECHNOLOGY PTE. LTD.	
Street Address:	8 UPPER CHANGI ROAD NORTH	
Internal Address:	APPLIED MATERIALS BUILDING	
City:	SINGAPORE	
State/Country:	SINGAPORE	
Postal Code:	506906	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15585842

CORRESPONDENCE DATA

Fax Number: (732)935-7122

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

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Correspondent Name: MOSER TABOADA/ALAN TABOADA

Address Line 1: 1030 BROAD STREET

Address Line 2: SUITE 203

Address Line 4: SHREWSBURY, NEW JERSEY 07702

ATTORNEY DOCKET NUMBER: 24918USA

NAME OF SUBMITTER: ALAN TABOADA

SIGNATURE: /ALAN TABOADA/

DATE SIGNED: 05/29/2017

Total Attachments: 2

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PATENT 504387515 REEL: 042521 FRAME: 0598

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1. PREETHAM RAO

31 Bishan St 21 #05-01 Rafflesia Condo Singapore 579800

2. ANANTHKRISHNA JUPUDI

50 West Coast Crescent, 05-09 Singapore, 128035

(hereinafter referred to as Assignors), have invented a certain invention entitled:

FLUORESCENCE BASED THERMOMETRY FOR PACKAGING APPLICATIONS

for which we have filed an application for a Patent of the United States on May 3, 2017, having Serial No. 15/585,842; and

WHEREAS, Applied Materials Singapore Technology Pte. Ltd., a company organized under the laws of Singapore, having a place of business at 8 Upper Changi Road North, Applied Materials Building, Singapore 506906 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignor, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt

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production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assigners in providing such cooperation shall be paid for by said Assignee.

- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

12/5/17 (DATE)

PREETHAM RAO

12/5/17 (DATE)

ANANTHERISHNA HEREN

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